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AMENDMENT TRANSMITTAL LETTER					Docket No. TESSERA 3.0-297		
Application No.		Filing Date		Examiner		Art Unit	
10/600,186		June 20, 2003		J. M. Im		2811	
Applicant(s): Mas	sud Beroz						
Invention: SIMPLIFIED STACKED CHIP ASSEMBLIES							
TO THE COMMISSIONER FOR PATENTS							
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.							
CLAIMS AS AMENDED							
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate			
Total Claims	19	- 20 =		х			
Independent Claims	3	- 3 =		x	•		
Multiple Dependent Claims (check if applicable)							
Other fee (please specify):							
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:						0.00	
x Large Entity Small Entity							
x No additional fee is required for this amendment.							
Please charge Deposit Account No in the amount of \$ A duplicate copy of this sheet is enclosed.							
A check in the amount of \$ to cover the filing fee is enclosed.							
Payment by credit card. Form PTO-2038 is attached.							
The Director is hereby authorized to charge and credit Deposit Account No12-1095 as described below. A duplicate copy of this sheet is enclosed.							
x Credit any overpayment.							
Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.							
The				Dated:	April 26,	2005	
Matthew E. Hanley Attorney Reg. No.: 51,773							
LERNER, DAVI 600 South Aver Westfield, New (908) 654-5000	D, LITTENBER nue West Jersey 07090		LZ & MENTL	IK, LLP			
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.							
	2/1						
Dated: April 26, 2005	Signature			(IVIALLITEW E. FIST	y/		

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I hereby certify that this correspondence is being deposited with the U.S. Postal Septice with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Dated: April 26, 2005

Signature: (Matthew E. Hanley)

Docket No: TESSERA 3.0-297

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Masud Beroz

: Confirmation No. 8841

Application No.: 10/600,186

: Group Art Unit: 2811

Filed: June 20, 2003

: Examiner: J. M. Im

For: SIMPLIFIED STACKED CHIP

ASSEMBLIES

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

RESPONSE

Dear Sir:

In response to the Office Action mailed December 2, 2004 and the Notice of Notice of Non-Compliant Amendment mailed April 12, 2005, applicant submits the following remarks.

A listing of claims begins on page 2 of this paper.

Remarks begin on page 6 of this paper.